Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

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Kingbright

3.0x2.5mm SURFACE MOUNT LED LAMP

APB3025ESGC — HIGH EFFICIENCY RED
SUPER BRIGHT GREEN

Features

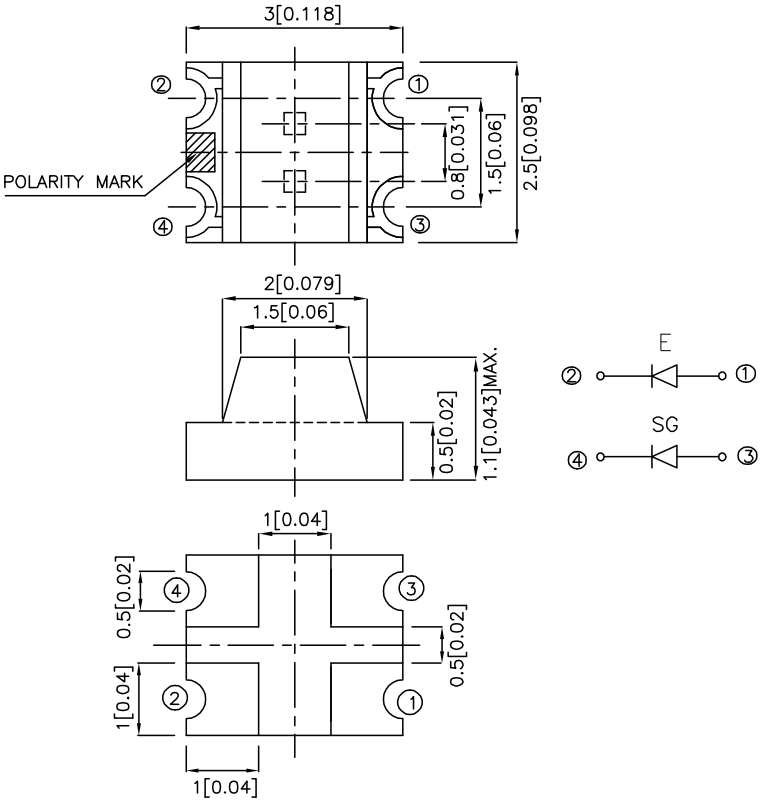
- 3.0mmx2.5mm SMT LED, 1.1mm THICKNESS.
- BI -COLOR,LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- RoHS COMPLIANT.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.2(0.008") unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
			Min.	Typ.	2θ1/2
APB3025ESGC	HIGH EFFICIENCY RED (GaAsP/GaP)	WATER CLEAR	4	12	120°
	SUPER BRIGHT GREEN (GaP)		4	12	

Note:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

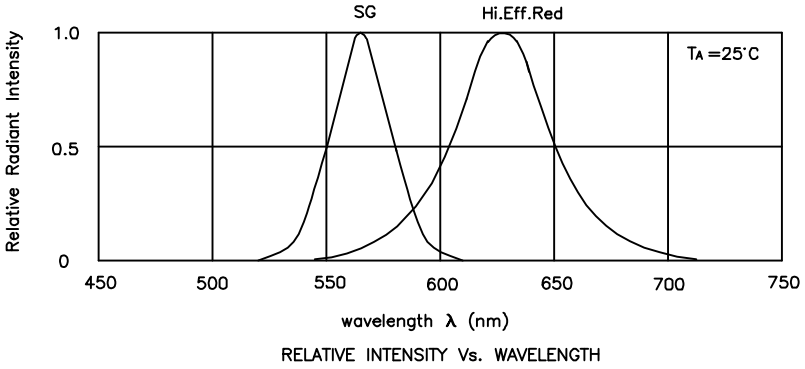
Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red Super Bright Green	627 565		nm	I_F=20mA
λD	Dominant Wavelength	High Efficiency Red Super Bright Green	625 568		nm	I_F=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red Super Bright Green	45 30		nm	I_F=20mA
C	Capacitance	High Efficiency Red Super Bright Green	15 15		pF	V_F=0V;f=1MHz
V_F	Forward Voltage	High Efficiency Red Super Bright Green	2.0 2.2	2.5 2.5	V	I_F=20mA
I_R	Reverse Current	High Efficiency Red Super Bright Green		10 10	uA	V_R = 5V

Absolute Maximum Ratings at T_A=25°C

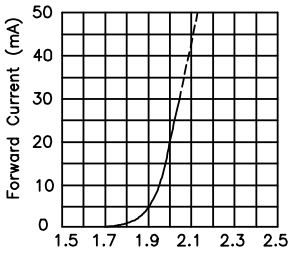
Parameter	High Efficiency Red	Super Bright Green	Units
Power dissipation	105	105	mW
DC Forward Current	30	25	mA
Peak Forward Current [1]	160	140	mA
Reverse Voltage	5		V
Operating / Storage Temperature	-40°C To +85°C		

Note:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

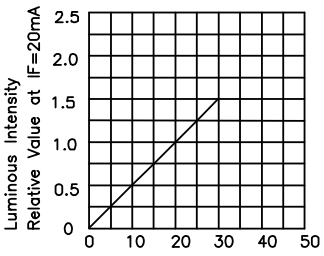


RELATIVE INTENSITY Vs. WAVELENGTH

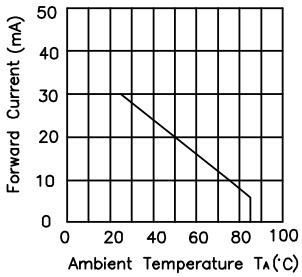
APB3025ESGC
High Efficiency Red



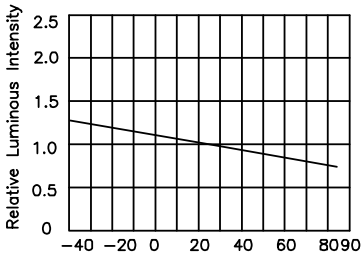
FORWARD CURRENT Vs.
FORWARD VOLTAGE



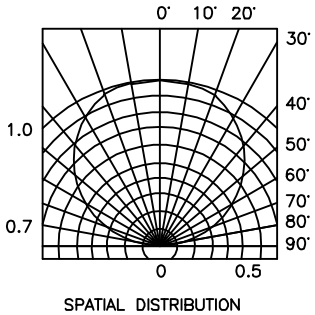
LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE

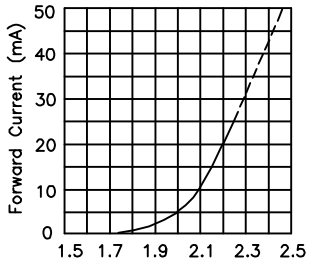


LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

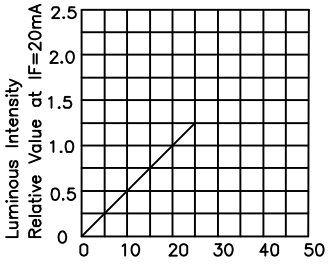


SPATIAL DISTRIBUTION

Super Bright Green

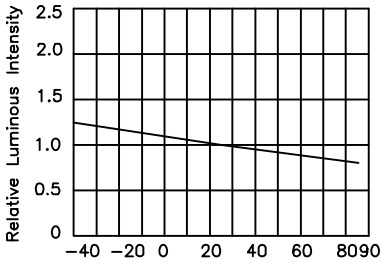


FORWARD CURRENT Vs.
FORWARD VOLTAGE

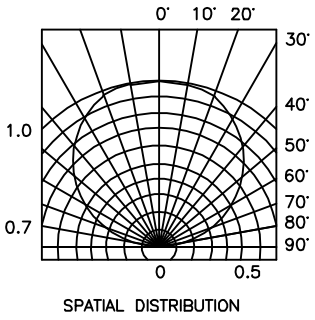


LUMINOUS INTENSITY Vs.
FORWARD CURRENT

FORWARD CURRENT
DERATING CURVE



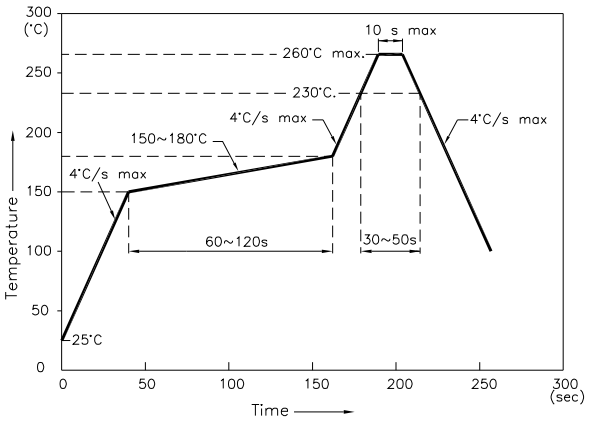
LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE



SPATIAL DISTRIBUTION

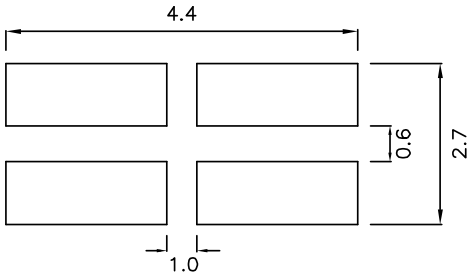
APB3025ESGC

Reflow Soldering Profile For Lead-free SMT Process.

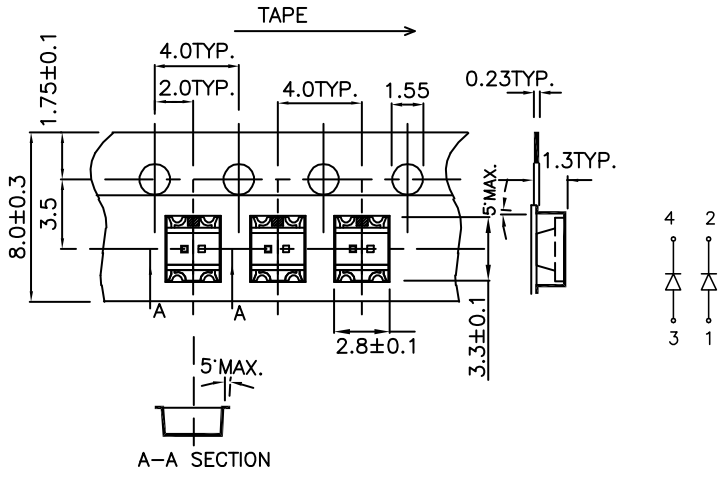


NOTES:
1. We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern

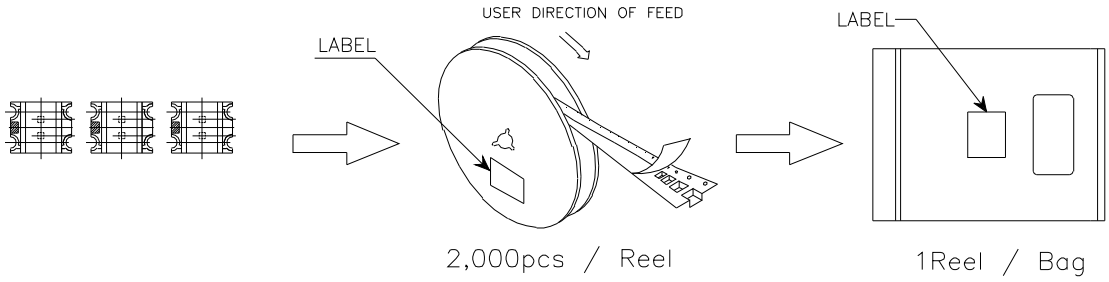


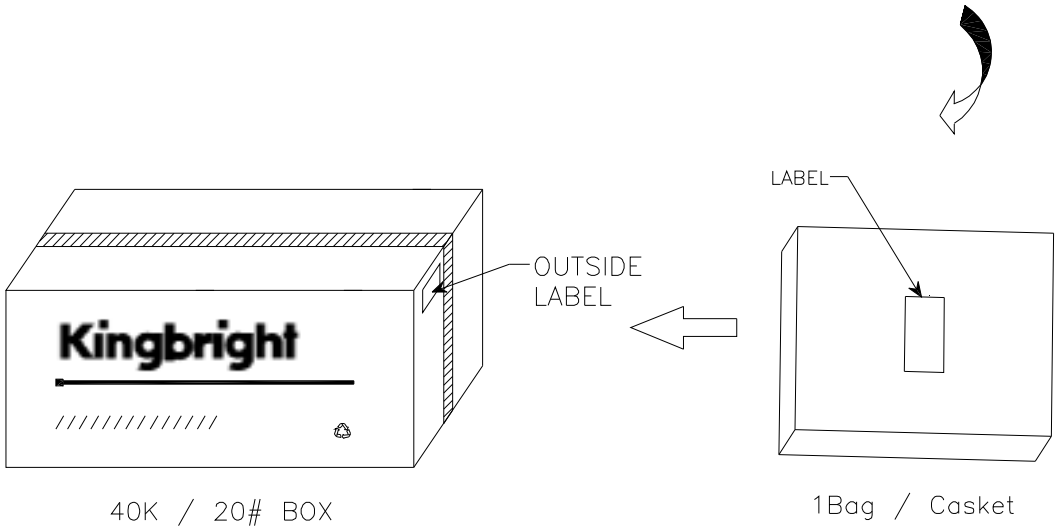
Tape Specifications
(Units : mm)

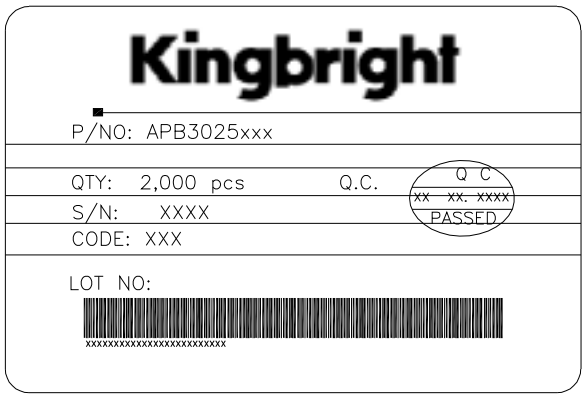


Kingbright

PACKING & LABEL SPECIFICATIONS APB3025ESGC







Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity/ luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity/ Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.